Substitute for form 1449A/PTO (modified)

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Application Number	10/734684		
Filing Date	December 12, 2003 Theiss, Steven D		
First Named Inventor			
Art Unit	1765		
Examiner Name			
Attorney Case Number	58355US002		

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Exam. Init.*	Cite No.	Document Number Doc. Number-(Kind Code if Known)	Publication Date or Issue Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns Relevant Passag Figures A	es or Relevant
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.					

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Theiss, Steven D
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DEO, Duy Vu Nguyen
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